SPECIFICATION

OF

LIQUID CRYSTAL DISPLAY MODULE

Apr-28-2022

CUSTOMER : **Avent**

Model No. : **UMSH-8065MD-11T**

Model version : **6**

Document Revision : **7**

CUSTOMER APPROVED SIGNATURE			

This specification need to be signed by purchaser or customer as a specification of products production and delivery from URT. Without signature of this specification , any purchase order for this model no. will be treated and considered that this specification is automatically acknowledged and accepted by purchaser or customer.

U.R.T.   UNITED RADIANT TECHNOLOGY CORPORATION

Joe Wu	Ashin Chiu	Jenny Wang	Apr-28-2022
APPROVED	CHECKED	PREPARED	Date

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This document has been signed by Digital Signature Approval System

Revision record

Document Revision	Model No. Version No.	Description	Revision by
0	UMSH-8065MD-T Version No. 0		Tony Chan Jeffry Chen 18-Jul-2007
1	UMSH-8065MD-11T Version No. 0	1.Modify the module number from UMSH-8065MD-T to UMSH-8065MD11T. 2.Modify the LED backlight to high brightness(500cd/㎡).	H.C. Lin Jeffry Chen 11-Jan-2008
2	UMSH-8065MD-11T Version No. 1	1. Modify the specification of DC Characteristics. 2. Modify the description of interface pin. 3. Modify the Back-light only Specification	H.C. Lin Jeffry Chen 25-Mar-2008
3	UMSH-8065MD-11T Version No. 2	1. Modify the specification of AC Characteristics. 2. Modify the description of interface pin.	H.C. Lin Jeffry Chen 27-Feb-2009
4	UMSH-8065MD-11T Version No. 3	Revise the Back-light only Specification.	H.C. Lin Jeffry Chen 16-Aug-2011
5	UMSH-8065MD-11T Version No. 4	Revise the Note.	William Don Naoki Tsai 26-Nov-2014
6	UMSH-8065MD-11T Version No. 5	Modify the packing mode.	Design Section 29-Nov-2018
7	UMSH-8065MD-11T Version No. 6	Change the LCD Driver IC to HX8238-D.	William Don Eric Wang 28-Apr-2022

CONTENTS:

1. BASIC SPECIFICATION

1.1 Mechanical specifications

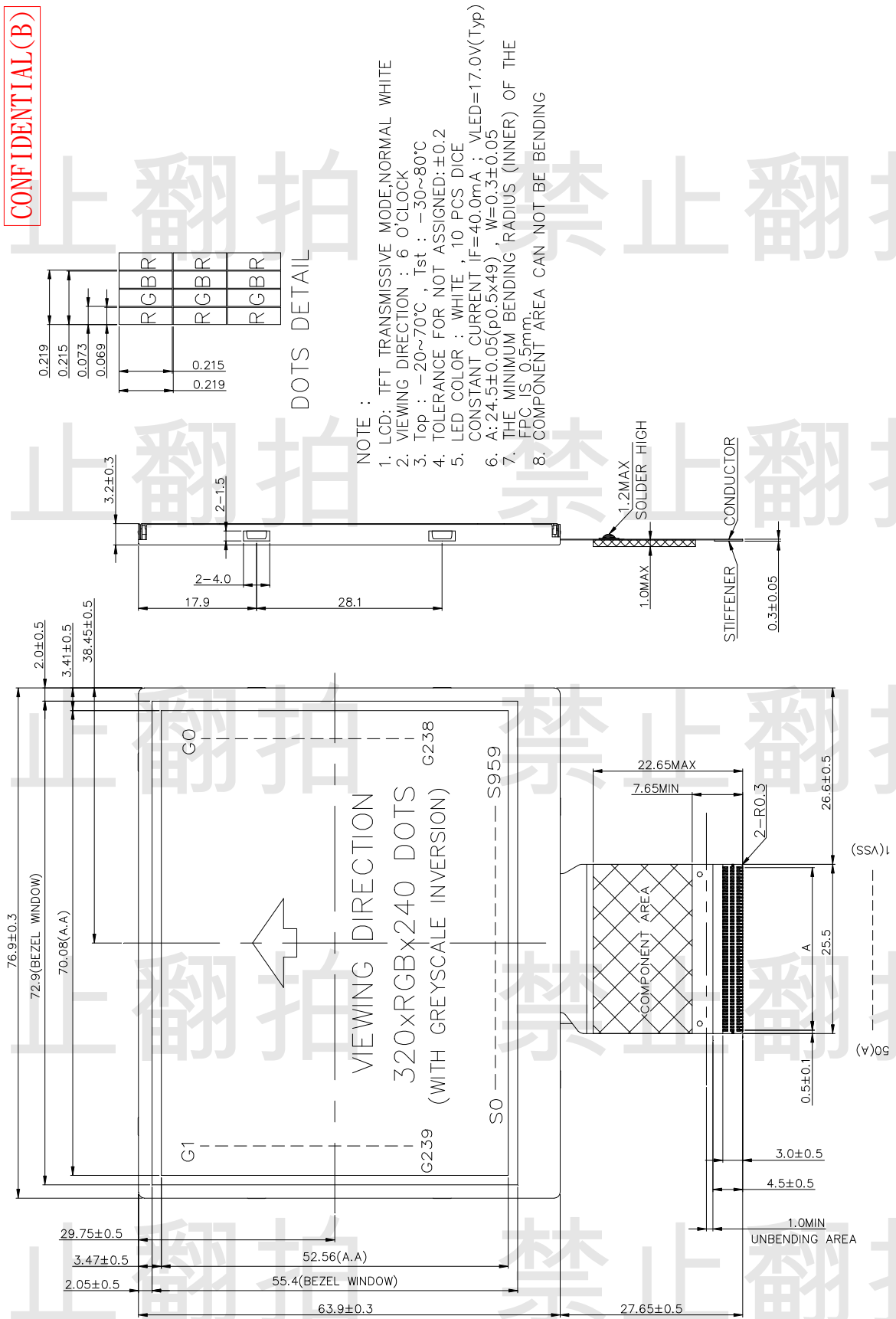| Items	Nominal Dimension	Unit
Active screen size	3.5" diagonal	-
Dot Matrix	320*RGB*240	dots
Module Size (W x H x T)	76.9 x 63.9 x 3.2	mm.
Active Area (W x H)	70.08 x 52.56	mm.
Dot Pitch (W x H)	0.219 x 0.219	mm.
Color depth	262K	color
Interface	8-bits serial/24-bits parallel RGB / CCIR601/656	-
Driving IC Package	COG	-

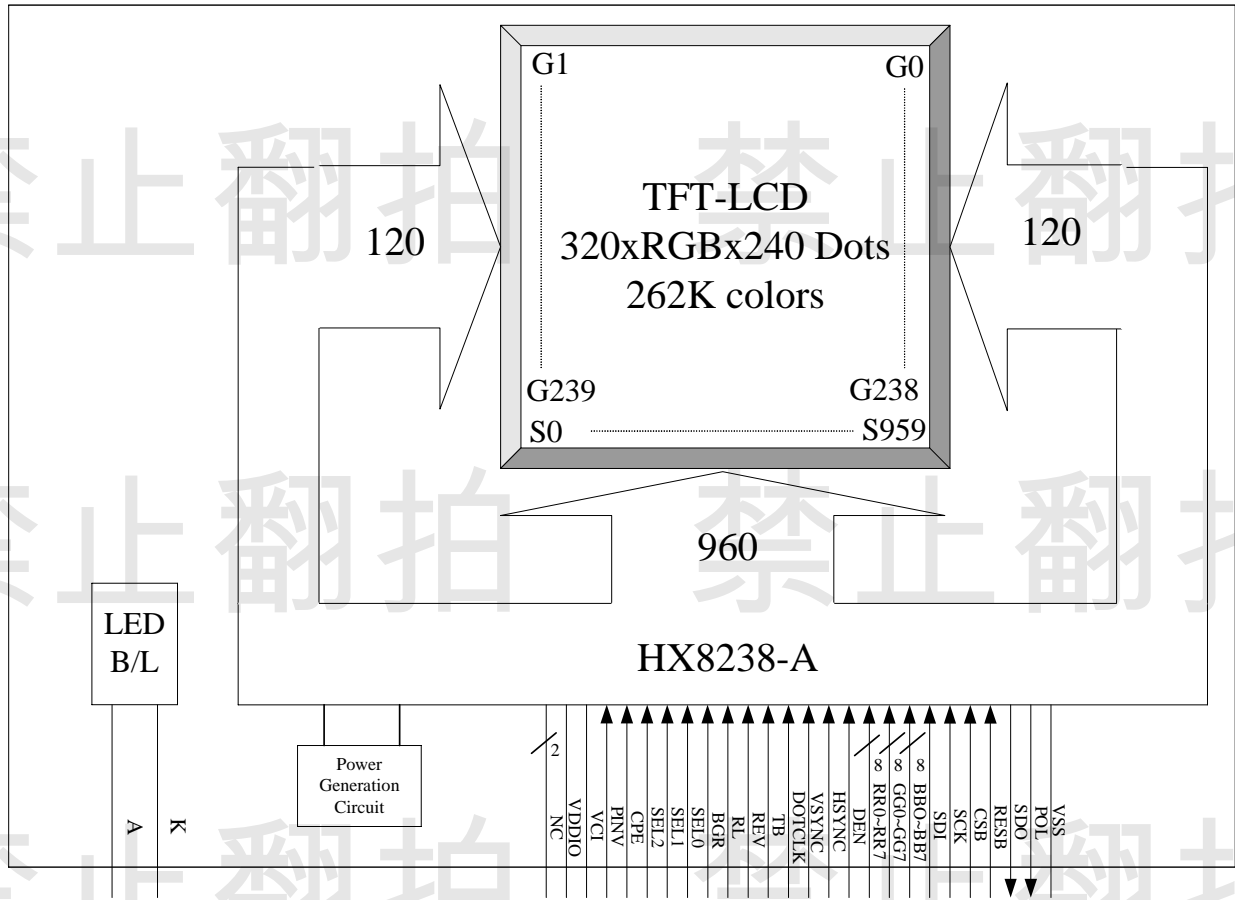 * The maximum color depth of this driver IC is 262K colors ,not 16.7M.

1.2 Display specification

Display	Descriptions	Note
LCD Type	a-Si TFT	-
LCD Mode	TN/Normally White	-
Polarizer Mode	Transmissive	-
Polarizer Surface	Normal	-
Pixel arrangement	RGB-stripe	-
Backlight Type	LED	-
Viewing Direction(Gray inversion	6 O'clock Direction	-

1.3 Outline dimension

DOTS DETAIL

RGBR
RGBR
RGBR

0.219
0.215
0.073
0.069

0.215
0.219

NOTE :
1. LCD: TFT TRANSMISSIVE MODE,NORMAL WHITE
2. VIEWING DIRECTION : 6 O'CLOCK
3. Top : −20～70℃ , Tst : −30～80℃
4. TOLERANCE FOR NOT ASSIGNED:±0.2
5. LED COLOR : WHITE , 10 PCS DICE
   CONSTANT CURRENT IF=40.0mA ; VLED=17.0V(Typ)
6. A:24.5±0.05(p0.5x49) , W=0.3±0.05
7. THE MINIMUM BENDING RADIUS (INNER) OF THE
   FPC IS 0.5mm.
8. COMPONENT AREA CAN NOT BE BENDING

3.2±0.3
2−1.5
2−4.0
17.9
28.1

1.2MAX
SOLDER HIGH
1.0MAX
STIFFENER
CONDUCTOR
0.3±0.05

2.0±0.5
3.41±0.5
38.45±0.5

G0
G238
S959

VIEWING DIRECTION
320xRGBx240 DOTS
(WITH GREYSCALE INVERSION)

S0

76.9±0.3
72.9(BEZEL WINDOW)
70.08(A.A)

G1
G239

29.75±0.5
3.47±0.5
2.05±0.5
63.9±0.3
52.56(A.A)
55.4(BEZEL WINDOW)

22.65MAX
7.65MIN
2−R0.3
26.6±0.5

COMPONENT AREA

1(VSS)
A
25.5
50(A)
0.5±0.1

3.0±0.5
4.5±0.5
1.0MIN
UNBENDING AREA
27.65±0.5

1.4 Block diagram:

TFT-LCD
320xRGBx240 Dots
262K colors

G1   G0

120   120

G239   G238
S0   S959

960

HX8238-A

LED B/L

A   K

Power Generation Circuit

NC
VDDIO
VCI
PINV
CPE
SEL2
SEL1
SEL0
BGR
RL
REV
TB
DOTCLK
VSYNC
HSYNC
DEN
RR0~RR7
GG0~GG7
BB0~BB7
SDI
SCK
CSB
RESB
SDO
POL
VSS

2
8 8 8

1.5 Interface Pin Connection:

Pin No.	Pin Name	I/O	Description
1	VSS	P	System ground pin of the IC. - Connect to system ground
2	POL	O	Polarity signal to monitor VCOM signal. - Leave it OPEN when not used
3	SDO	O	Data output pin in serial mode. - Leave it OPEN when not used
4	RESB	I	System reset pin. Internal pull high.
5	CSB	I	Chip select pin of serial interface. Internal pull high. - Leave it OPEN when not used.
6	SCK	I	Clock pin of serial interface. Internal pull high. - Leave it OPEN when not used
7	SDI	I	Data input pin in serial mode. Internal pull high. - Leave it OPEN when not used
8~31	BB [0:7] GG [0:7] RR [0:7]	I	Graphic Data Input Pins. Internal pull low. - RR [0:7]: Red Data - 8-bits - GG [0:7]: Green Data - 8-bits - BB [0:7]: Blue Data - 8-bits For 8 bit interface, only RR[0:7] are used. For unused pins, please connect to VSS or floating.
32	DEN	I	Display enable pin from controller. Connect to VDDIO or floating if not used.
33	HSYNC	I	Line synchronization signal. Internal pull high. - Fixed to VDDIO or floating if not used
34	VSYNC	I	Frame synchronization signal. Internal pull high. - Fixed to VDDIO or floating if not used.
35	DOTCLK	I	Dot-clock signal and oscillator source.

Pin No.	Pin Name	I/O	Description
36	TB	I	Input pin to select the Gate driver scan direction. - Connect to VSS for Gate scan from G239 to G0 (reverse scan) - Connect to VDDIO for Gate scan from G0 to G239 (normal scan)
37	REV	I	Input pin to select the display reversion. - Connect to VDDIO mapping data '0' to maximum pixel voltage for normally white panel - Connect to VSS for mapping data '0' to minimum pixel voltage for normally black panel
38	RL	I	Input pin to select the Source driver data shift direction. - Connect to VDDIO for display first RGB data at S0-S2. - Connect to VSS for display first RGB data at S959-S957.
39	BGR	I	Input pin to select the color mapping. - Connect to VDDIO for Blue-Green-Red mapping. - Connect to VSS for Red-Green-Blue mapping.
40~42	SEL0~2	I	Input pin to select input interface mode.

Input pin to select input interface mode.

SEL2	SEL1	SEL0	Format	Operating Frequency
0	0	0	Parallel-RGB data format (only support stripe type color filter)	7.5MHz
0	0	1	Serial-RGB data format	19.5MHz
0	1	0	CCIR 656 data format (640RGB)	24.54MHz
0	1	1	CCIR 656 data format (720RGB)	27MHz
1	0	0	YUV mode A data format (Cr-Y-Cb-Y)	24.54MHz
1	0	1	YUV mode A data format (Cr-Y-Cb-Y)	27MHz
1	1	0	YUV mode B data format (Cb-Y-Cr-Y)	27MHz
1	1	1	YUV mode B data format (Cb-Y-Cr-Y)	24.54MHz

Pin No.	Pin Name	I/O	Description
43	CPE	I	Input pin to enable internal charge pump circuit. Internal pull high. - Connect to VDDIO to enable internal charge pump. - Connect to VSS to disable internal charge pump
44	PINV	I	Control the polarity of POL signal. Internal pull low. - Connect to VDDIO, POL phase is reversed with internal VCOM signal. - Connect to VSS, POL phase is same with internal VCOM signal.
45	VCI	P	Power Supply for Analog Circuits.
46	VDDIO	P	Voltage input pin for I/O logic.
47	NC	-	No connection.
48	NC	-	No connection.
49	K	P	Backlight LED's cathode.
50	A	P	Backlight LED's anode.

2. ELECTRICAL CHARACTERISTICS

2.1 Absolute Maximum Ratings

Items	Symbol	Min.	Max.	Unit
Input voltage	VCI	VSS-0.3	5.0	V
Supply Voltage	VDDIO	VSS-0.3	4.0	V
Operate temperature range	TOP	-20	70	℃
Storage temperature range	TST	-30	80	℃

2.2 DC Characteristics

Items	Symbol	Min.	Typ.	Max.	Unit	Condition
Power supply voltage	VCI	2.5	3.3	3.6	V	
Power supply pin of IO pins	VDDIO	1.4	3.3	3.6	V	
Current consumption	$I_{VCI}+I_{VDDIO}$	-	-	16	mA	NOTE
Dot Clock	DCK	-	7.5	10	MHz	
Serial Clock	XSCK	-	19.5	30	MHz	

NOTE : The method to illuminate the LCD panel is using the 2-4-7commend under the
measuring condition.

Measuring Condition :

Standard Value MAX.

Ta = 25℃

V_{CI} = 3.3V

VDDIO = 3.3V

Dot Clock = 7.5MHz

Display Patten
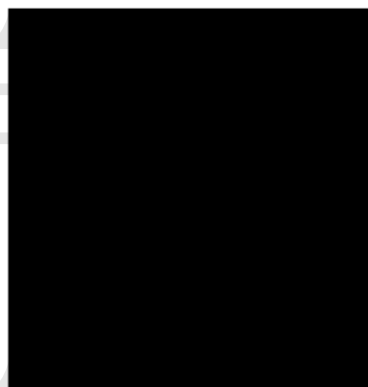
0 gray black pattern

2.3 Back-light only Specification:

Parameter	Symbol	Min	Typ	Max	Unit	Test Condition	Note
Supply Current	If	-	40	-	mA	Ta=25℃	-
Supply Voltage	VF	-	17	-	V	Ta=25℃	-
Half-Life Time	Lf	-	50000	-	hrs	-	1

Note1: The " Half-Life Time" is defined as the LED chip brightness decreases to 50% than original brightness, Based on Ta 25±2℃ ,60±10% RH condition .

2.4 AC Characteristics

2.4.1 8-bits serial/24-bits parallel RGB

AC Characteristics
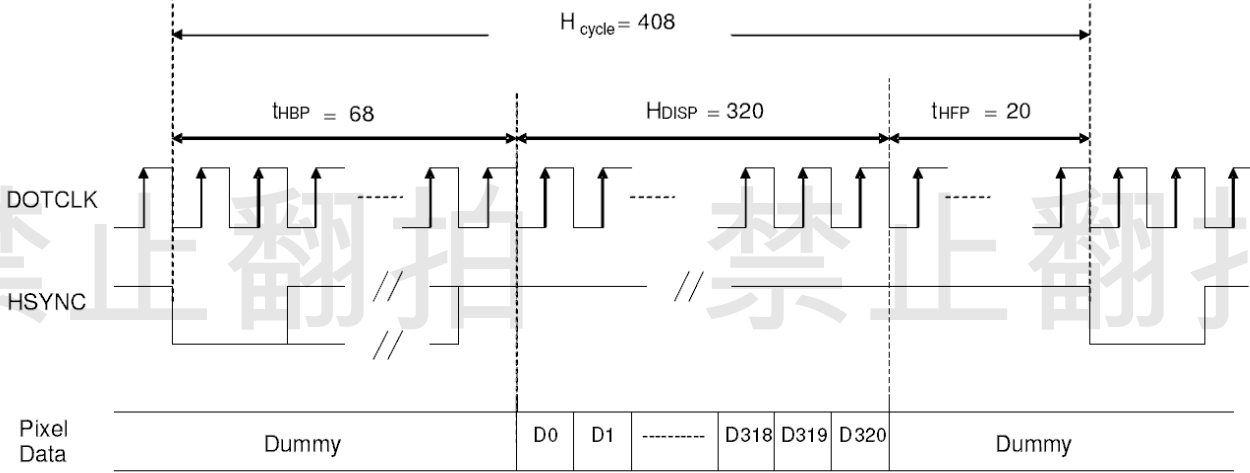(Unless otherwise specified, Voltage Referenced to Vss,   T$_A$ = 25℃)
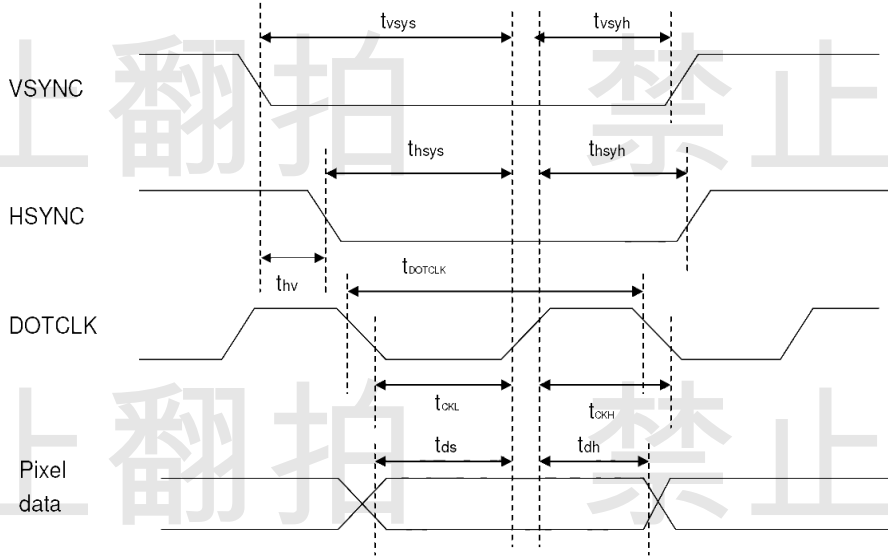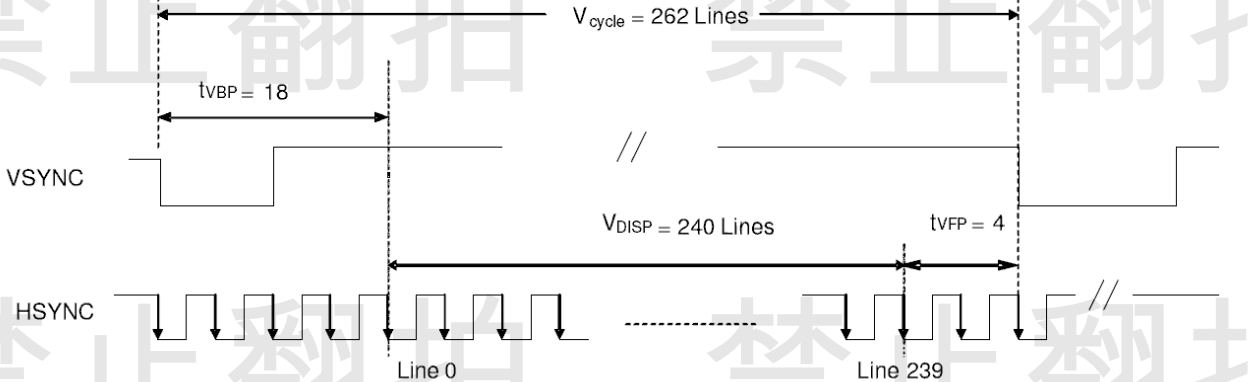

Figure 14. 1 Pixel Timing

Characteristics	Symbol	Min.		Typ.		Max.		Unit
		24bit	8bit	24bit	8bit	24bit	8bit	
DOTCLK Frequency	fDOTCLK	-		7.5	19.5	10	30	MHz
DOTCLK Period	tDOTCLK	100	33.3	133	51.3	-	-	ns
Vertical Sync Setup Time	tvsys	20	10	-	-	-	-	ns
Vertical Sync Hold Time	tvsyh	20	10	-	-	-	-	ns
Horizontal Sync Setup Time	thsys	20	10	-	-	-	-	ns
Horizontal Sync Hold Time	thsyh	20	10	-	-	-	-	ns
Phase difference of Sync Signal Falling Edge	thv	1		-		240		tDOTCLK
DOTCLK Low Period	tCKL	50	15	-	-	-	-	ns
DOTCLK High Period	tCKH	50	15	-	-	-	-	ns
Data Setup Time	tds	12	8	-	-	-	-	ns
Data hold Time	tdh	12	8	-	-	-	-	ns
Reset pulse width	tRES	10		-		-		us

Note: External clock source must be provided to DOTCLK pin of HX8238-A. The driver will not operate if absent of the clocking signal.

Table 14. 1 Pixel Timing

H_{cycle} = 408

t_{HBP} = 68   H_{DISP} = 320   t_{HFP} = 20

DOTCLK

HSYNC

Pixel Data | Dummy | D0 | D1 | ---------- | D318 | D319 | D320 | Dummy

a) Horizontal Data Transaction Timing

V_{cycle} = 262 Lines

t_{VBP} = 18

VSYNC

V_{DISP} = 240 Lines   t_{VFP} = 4

HSYNC

Line 0   Line 239

b) Vertical Data Transaction Timing

Figure 14. 2 Data transaction timing in parallel RGB (24 bit) interface (SYNC mode)

Characteristics		Symbol	Min		Typ		Max		Unit
			24bit	8 bit	24bit	8 bit	24bit	8 bit	
DOTCLK Frequency		fDOTCLK	-	-	7.5	19.5	10	30	MHz
DOTCLK Period		tDOTCLK	100	33.3	133	51.3	-	-	ns
Horizontal Frequency (Line)		fH	-		18.37		22.35		KHz
Vertical Frequency (Refresh)		fV	-		70		90		Hz
Horizontal Back Porch		tHBP	-	-	68	204	-	-	tDOTCLK
Horizontal Front Porch		tHFP	-	-	20	60	-	-	tDOTCLK
Horizontal Data Start Point		tHBP	-	-	68	204	-	-	tDOTCLK
Horizontal Blanking Period		tHBP + tHFP	-	-	88	264	-	-	tDOTCLK
Horizontal Display Area		HDISP	-	-	320	960	-	-	tDOTCLK
Horizontal Cycle		Hcycle	-	-	408	1224	450	1350	tDOTCLK
Vertical Back Porch		tVBP	-		18		-		Lines
Vertical Front Porch		tVFP	-		4		-		Lines
Vertical Data Start Point		tVBP	-		18		-		Lines
Vertical Blanking Period		tVBP + tVFP	-		22		-		Lines
Vertical Display Area	NTSC	VDISP	-		240		-		Lines
	PAL				280(PALM=0)				
					288(PALM=1)				
Vertical Cycle	NTSC	Vcycle	-		262		350		Lines
	PAL				313				

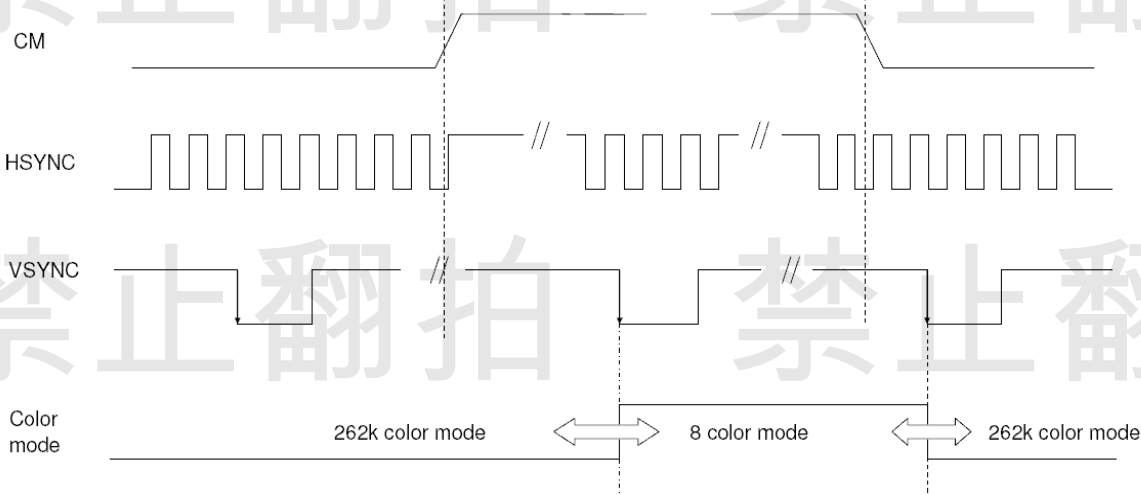Table 14. 2 Data Transaction Timing in Normal Operating Mode
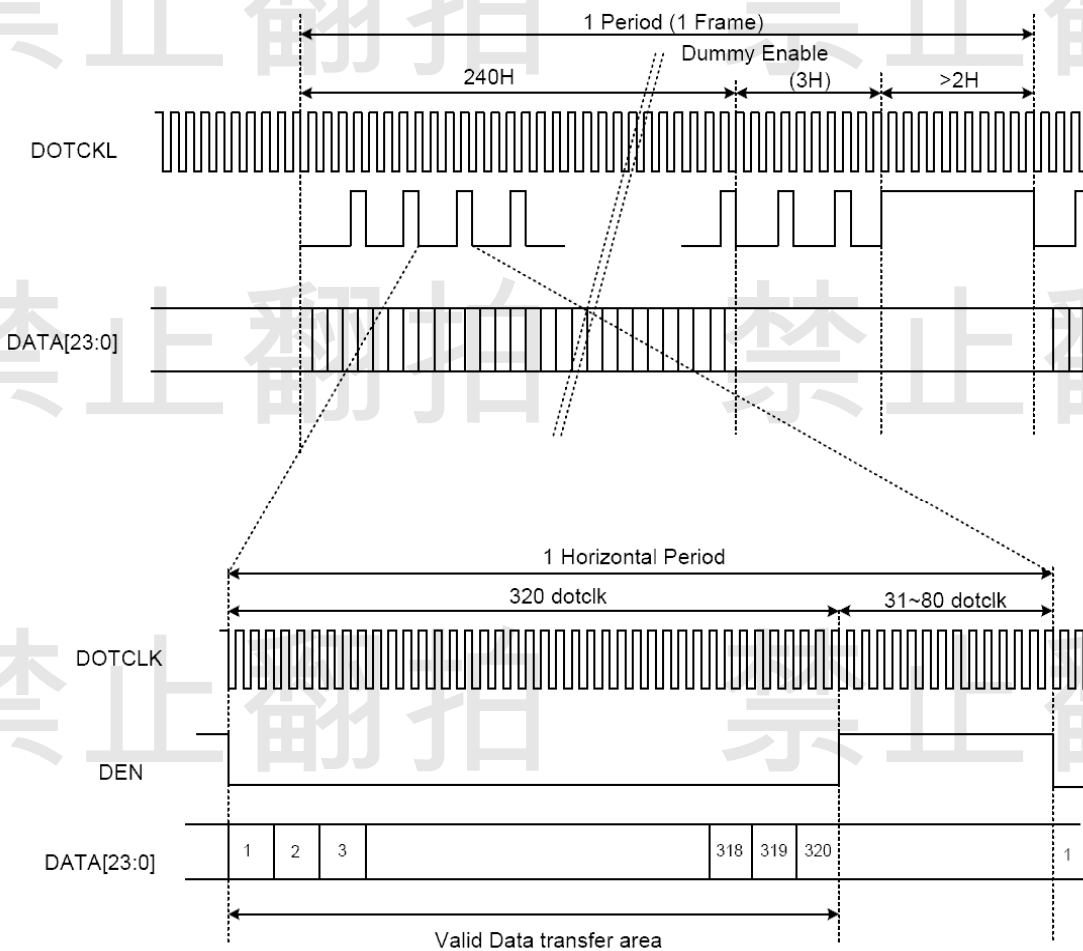
Figure 14. 3 Signal timing in DE mode

Note: The color mode conversion starts at the first falling edge of VSYNC after stage change of CM.

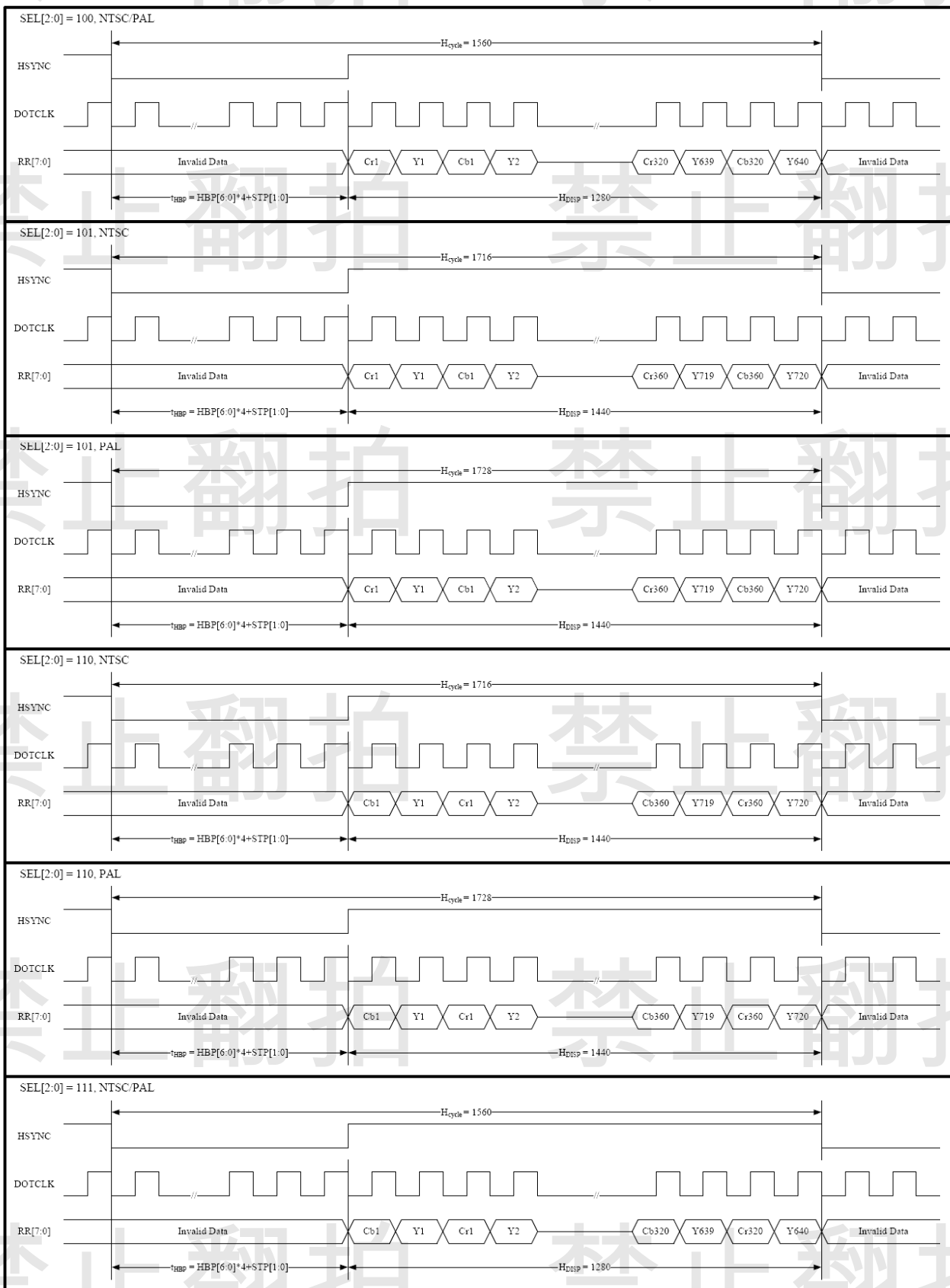**Figure 14. 4 Color mode conversion timing**

2.4.2 CCIR601 Timing
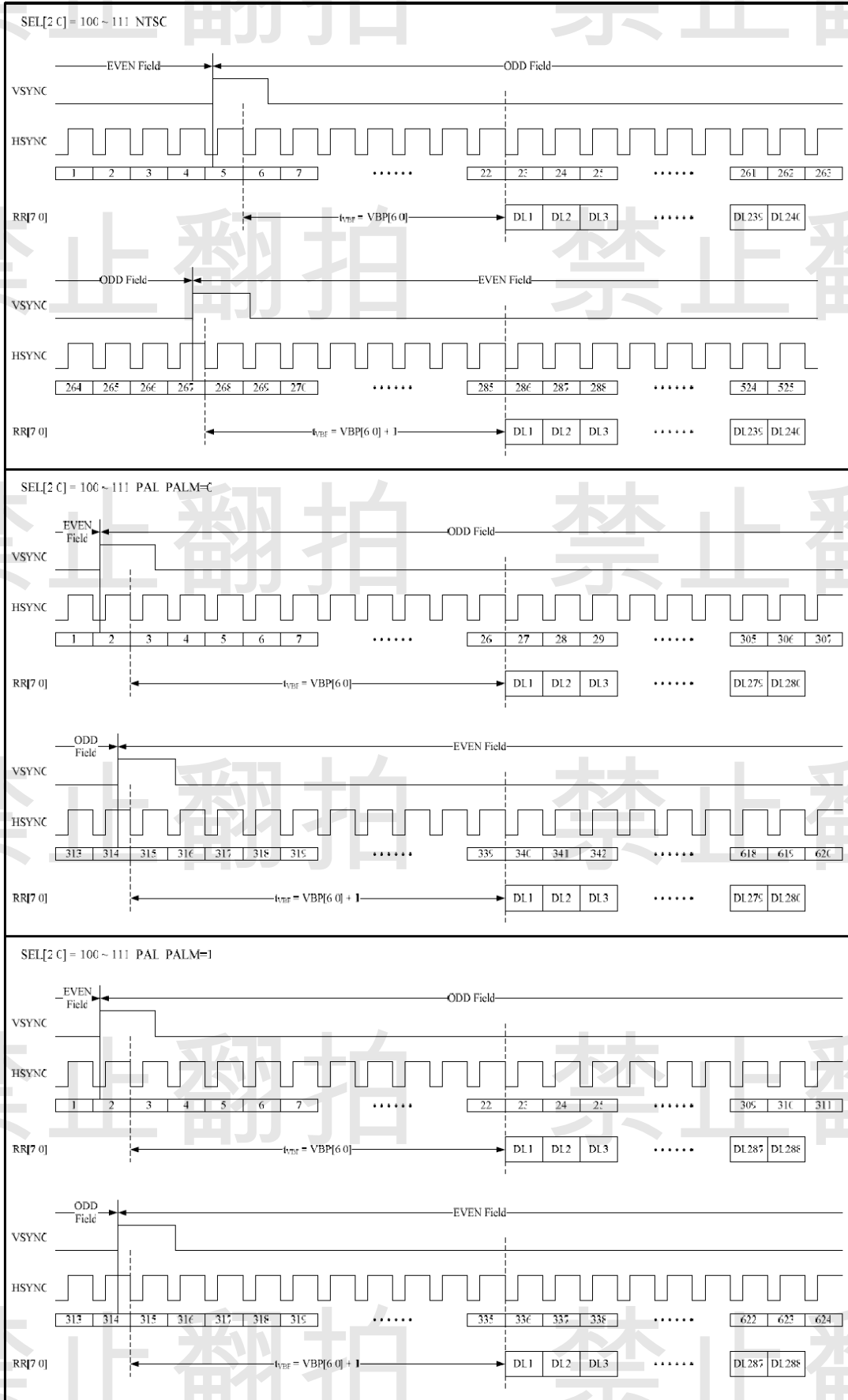

Figure 14. 5 CCIR601 horizontal timing
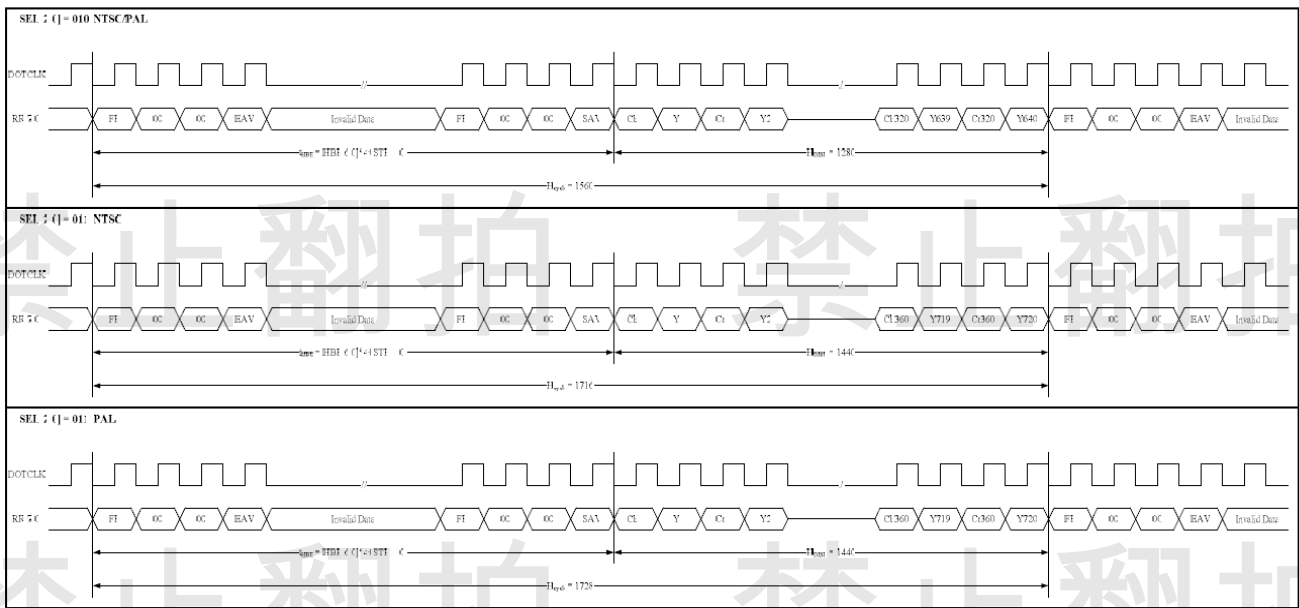
Figure 14. 6 CCIR601 vertical timing

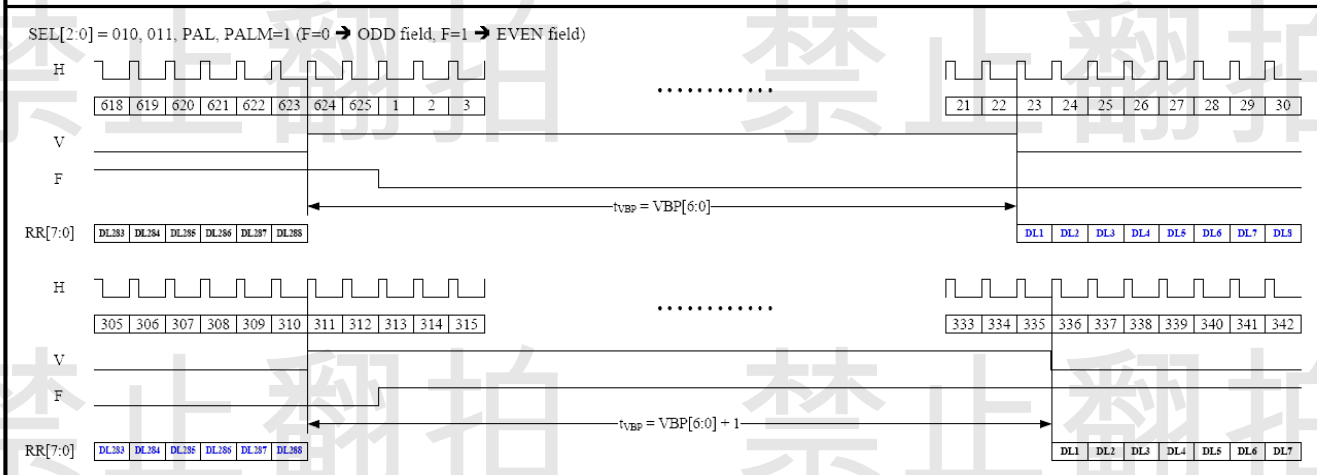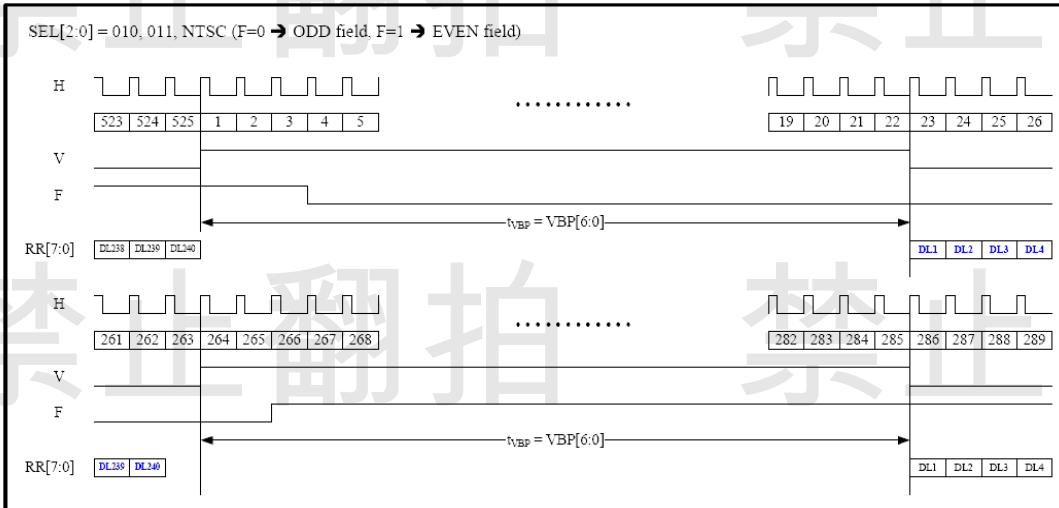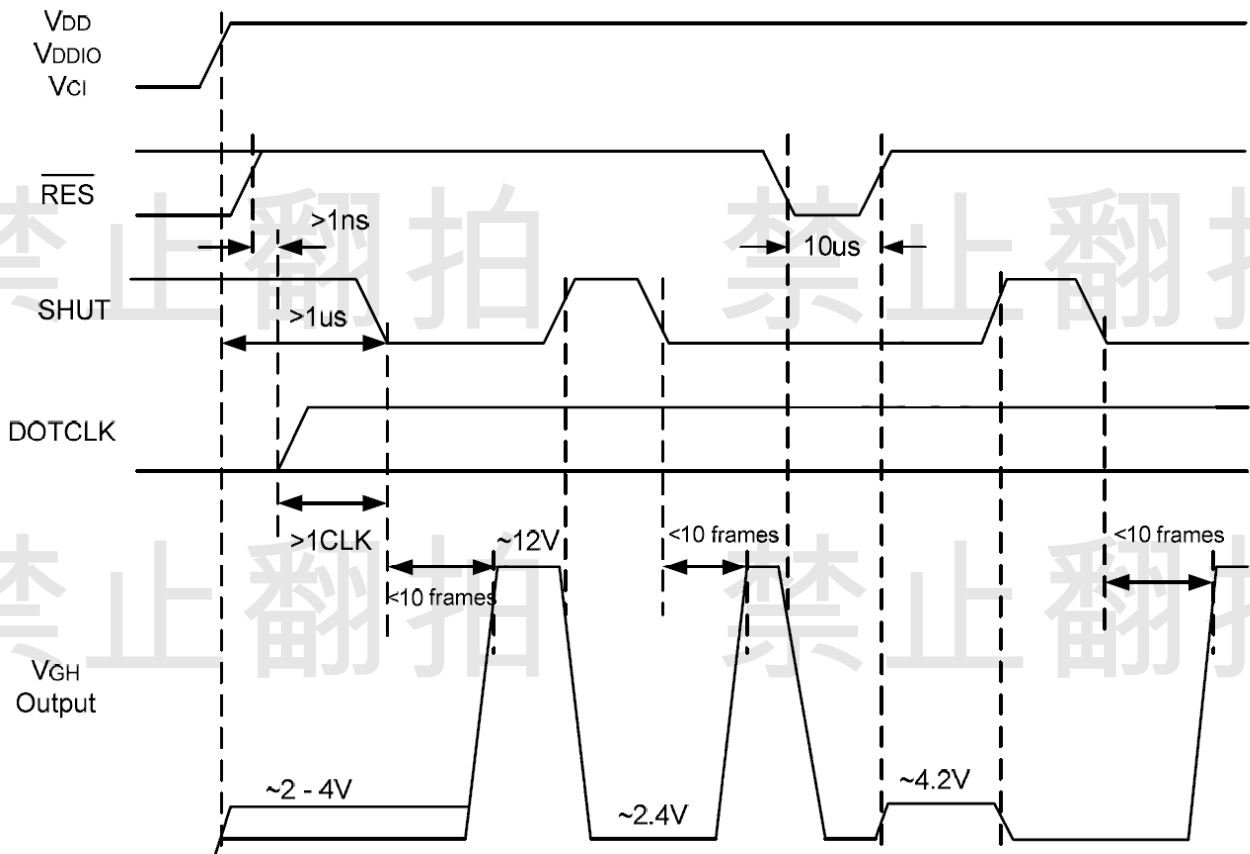## 2.4.3 CCIR656 Timing

Figure 14. 7 CCIR656 horizontal timing
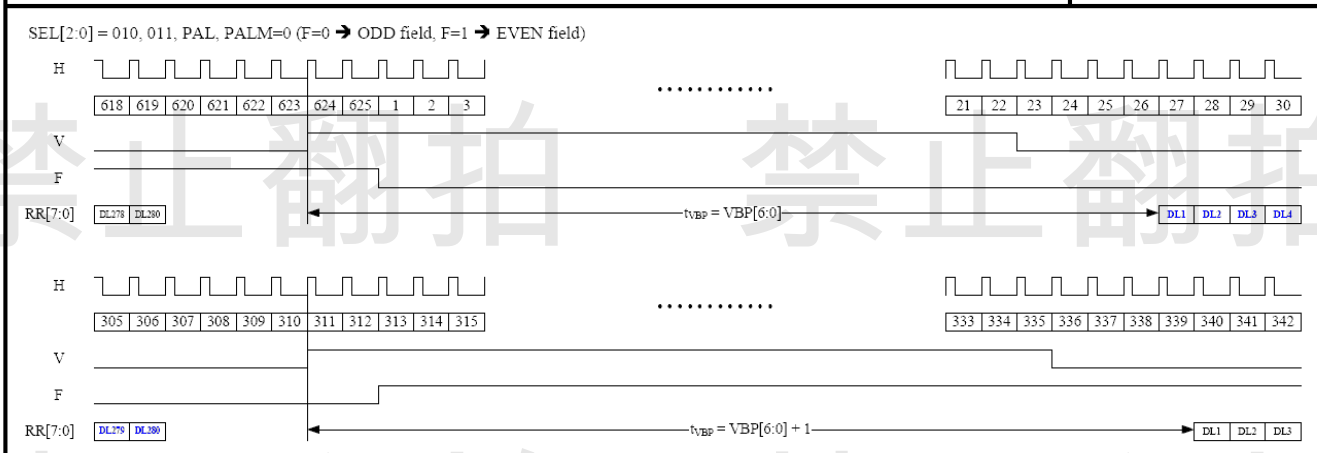
Figure 14. 8 CCIR656 vertical timing

Figure 14. 9 VGH Output Against SHUT & RES

Note: (1) The minimum cycle time of SHUT is 10 + 2 frames.
(2) DOTCLK must be provided for boosting of VGH. The above timing diagram assumed voltages and DOTCLK are continuous supplied after power on.
(3) VGH and VGL will be forced to VSS at the low stage of RESB.
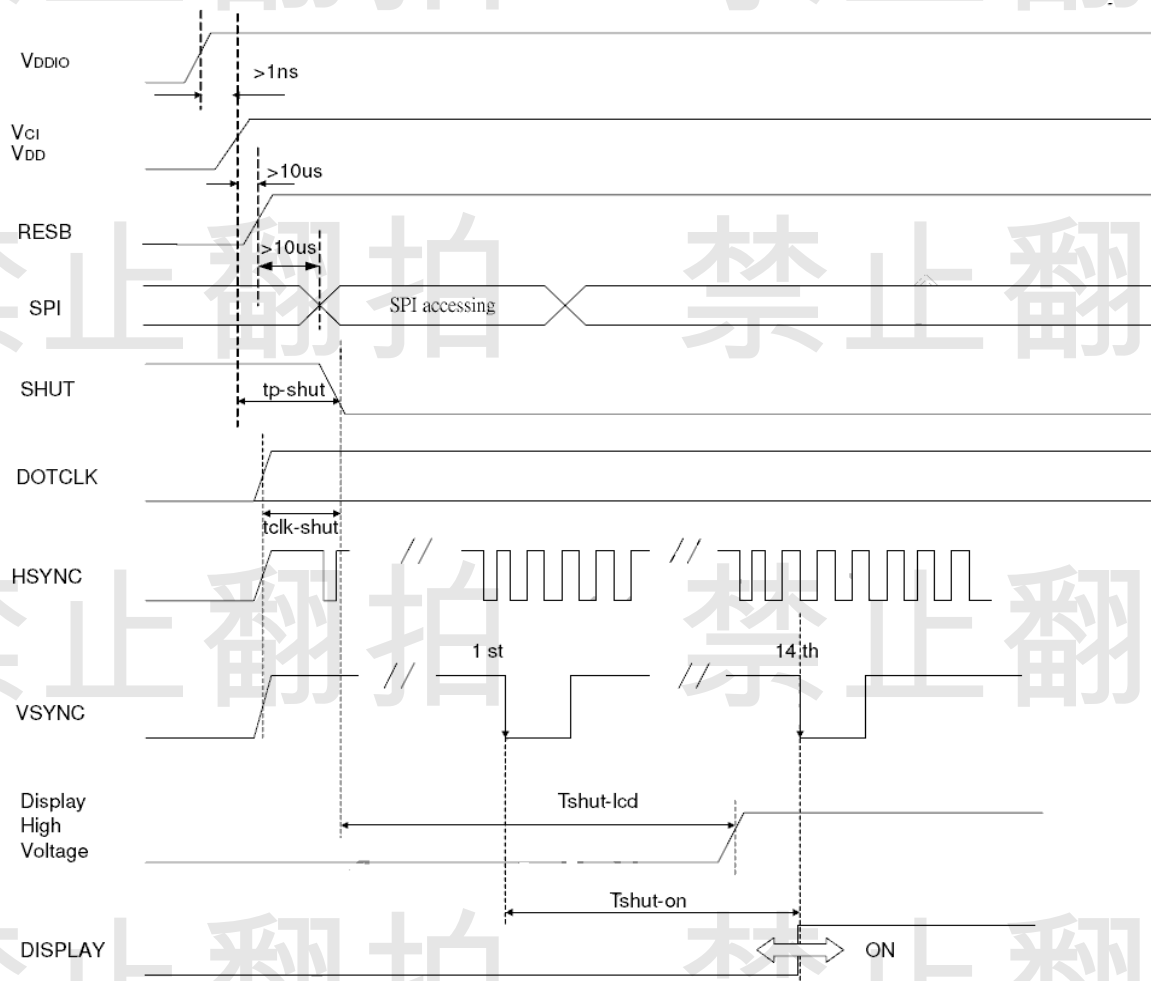(4) The minimum pulse width of RESB is 10us.

2.4.4 Power Up Sequence

Figure 14. 10 Power Up Sequence

Characteristics	Symbol	Min	Typ	Max	Units
VDDD / VDDIO on to falling edge of SHUT	tp-shut	1	-	-	us
DOTCLK	tclk-shut	1	-	-	clk
Falling edge of SHUT to LCD power on	tshut-lcd	-	-	128	ms
Falling edge of SHUT to display start -1 line: 408 clk -1 frame: 262 line -DOTCLK = 7.5MHz	tshut-on	-	-	14	frame
		-	166	232.4	ms

Note: It is necessary to input DOTCLK before the falling edge of SHUT.

Display starts at 10th falling edge of VSTNC after the falling edge of SHUT.

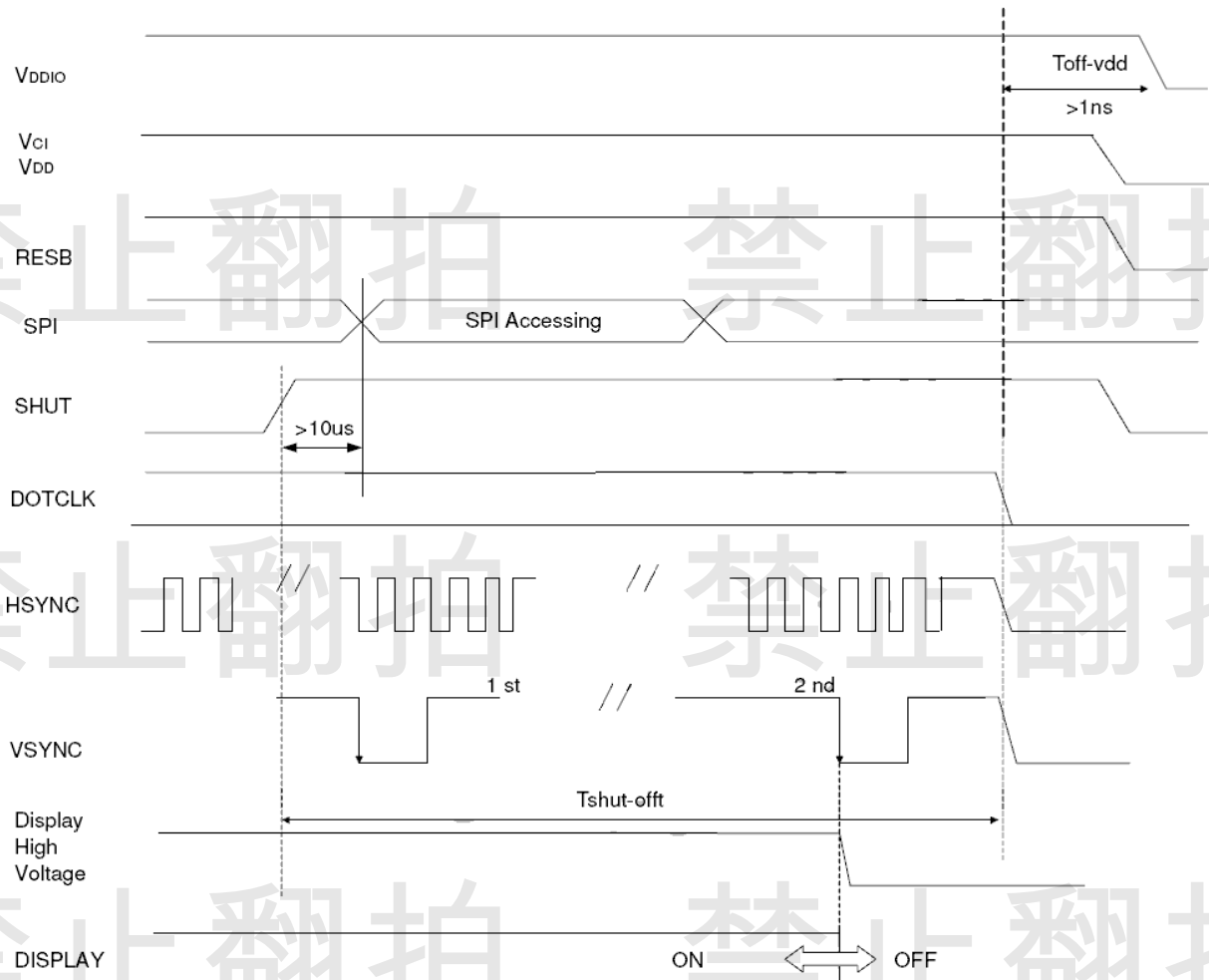**Table 14. 3 Power Up Sequence**

2.4.5 Power Down Sequence

Figure 14. 11 Power Down Sequence

Characteristics	Symbol	Min	Typ	Max	Uni
Rising edge of SHUT to display off	tshut-off	2	-	-	frame
-1 line: 408 clk -1 frame: 262 line -DOTCLK = 7.5MHz		33.4	-	-	ms
Input-signal-off to VDDD / VDDIO off	toff-vdd	1	-	-	us

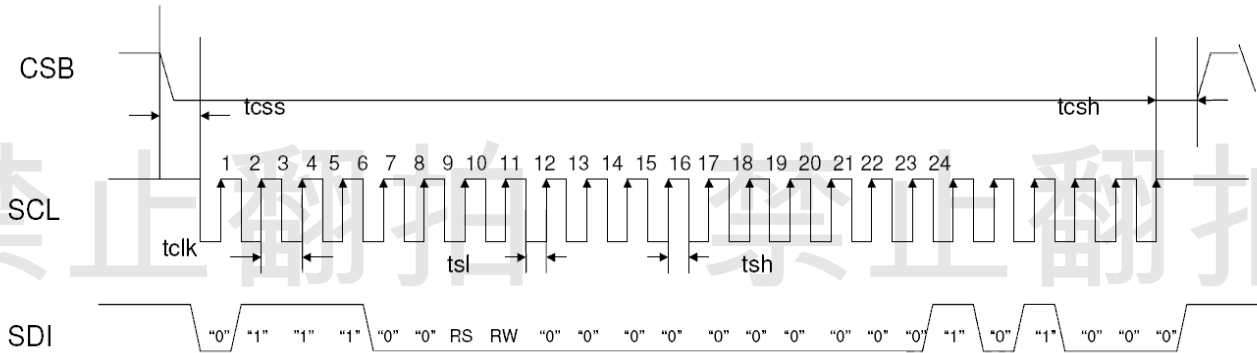**Note:** DOTCLK must be maintained at lease 2 frames after the rising edge of SHUT.

Display become off at the 2nd falling edge of VSTNC after the falling edge of SHUT.

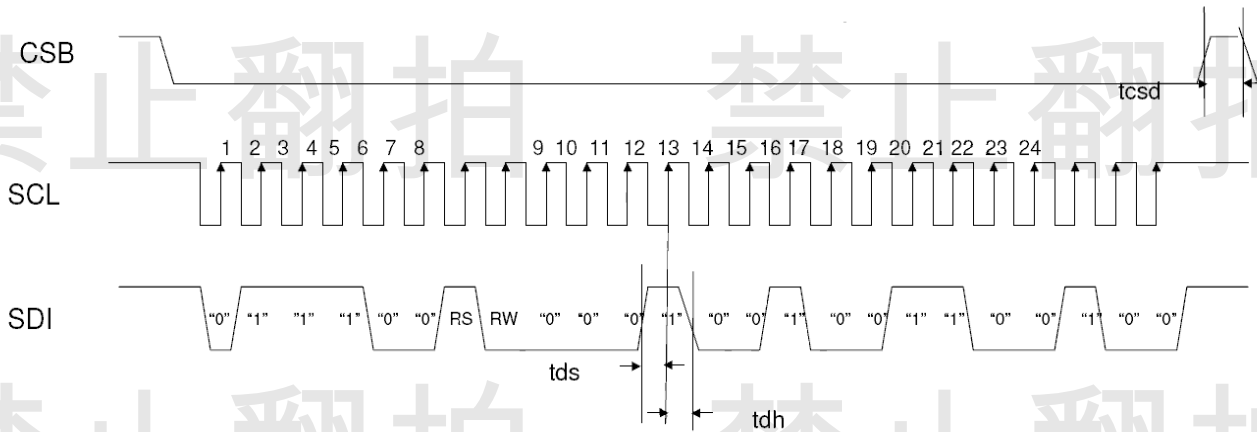If RESET signal is necessary for power down, provide it after the 2-frames-cycle of the SHUT period.

Table 14. 4 Power Down Sequence

2.4.6 SPI Timing

First Transmission (Register)

Second Transmission (Data)

Note: The example transmit "0x1264h" to register R28h.
SPID connected to VSS.

Figure 14. 12 SPI interface Timing Diagram & Transaction Example

Characteristics	Symbol	Min	Typ	Max	Unit
Serial C ock Frequency	fclk	-	-	20	MHz
Serial Clock Cycle Time	tclk	50	-	-	ns
Clock Low Width	tsl	25	-	-	ns
Clock High Width	tsh	25	-	-	ns
Chip Select Setup Time	tcss	0	-	-	ns
Chip Select Hold Time	tcsh	10	-	-	ns
Chip Select High Delay Time	tcsd	20	-	-	ns
Data Setup Time	tds	5	-	-	ns
Data Hold Time	tdh	10	-	-	ns

Table 14. 5 SPI Timing

2.4.7 Command (Recommend by U.R.T.)

LCD_Initial_HX-8238:

COMMAND	CODE	DESCRIPTION
R02H	0200	LCD-Driving-Waveform Control
R03H	6364	Power control 1
R04H	0440	Input Data and Color Filter Control
R0DH	3221	Power Control 2
R0EH	3100	Power Control 3

Adjust the Gamma Curve:

COMMAND	CODE	DESCRIPTION
R30H	0000	Gamma Control 1
R31H	0407	Gamma Control 1
R32H	0202	Gamma Control 1
R33H	0000	Gamma Control 1
R34H	0505	Gamma Control 1
R36H	0707	Gamma Control 1
R37H	0000	Gamma Control 1
R3AH	0904	Gamma Control 2
R3BH	0904	Gamma Control 2

3. OPTICAL CHARACTERISTICS
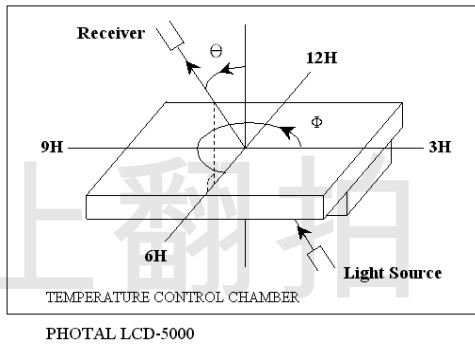
3.1 Characteristics

Electrical and Optical Characteristics

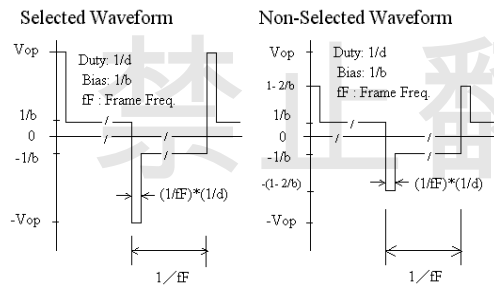| No.	Item			symbol / temp.		Min.	Typ.	Max.	Unit	Note
1	Response Time			Tr	25	-	15	20	ms	2
				Tf	25	-	35	50		
2	Viewing Angle	Hor.	Cr>10	θ_{2+}	$\Phi = 0°$	60	80	-	degree	3
				θ_{2-}	$\Phi = 180°$	60	80	-		
		Ver.		θ_{1+}	$\Phi = 270°$	60	80	-		
				θ_{1-}	$\Phi = 90°$	30	45	-		
3	Contrast Ratio			Cr	25	400	800	-	-	4
4	Red x-code			Rx	25	0.58	0.63	0.68	-	5
	Red y-code			Ry		0.31	0.36	0.41		
	Green x-code			Gx		0.29	0.34	0.39		
	Green y-code			Gy		0.54	0.59	0.64		
	Blue x-code			Bx		0.09	0.14	0.19		
	Blue y-code			By		0.05	0.10	0.15		
	White x-code			Wx		0.27	0.32	0.37		
	White y-code			Wy		0.30	0.35	0.40		
	Brightness			Y		500	700	-	cd/m^2	
5	Brightness Uniformity				25	80	-	-	%	6

3.2 Definition of optical characteristics

Measurement condition :

Transmissive and Transflective type

Receiver
Θ
12H
9H
Φ
3H
6H
Light Source
TEMPERATURE CONTROL CHAMBER
PHOTAL LCD-5000

[Note 1] Definition of LCD Driving Vop and Waveform :

Vop Definition

Contrast Ratio

Voltage

Vop= Driving Voltage at
Max. Contrast Ratio

Selected Waveform

V_{op}
Duty: 1/d
Bias: 1/b
fF : Frame Freq.
1/b
0
-1/b
$(1/fF)*(1/d)$
$-V_{op}$
$1/fF$

Non-Selected Waveform

V_{op}
Duty: 1/d
1- 2/b
Bias: 1/b
fF : Frame Freq.
1/b
0
-1/b
-(1- 2/b)
$(1/fF)*(1/d)$
$-V_{op}$
$1/fF$
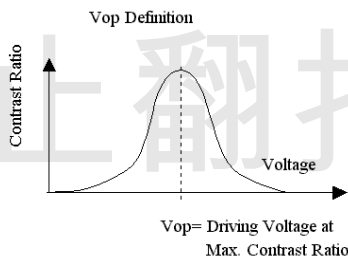
[Note 2] Definition of Response Time

for Positive type

Selected State   Non-Selected State   Selected State

Transmittance

90%   90%

10%   10%

Tf   Tr   time
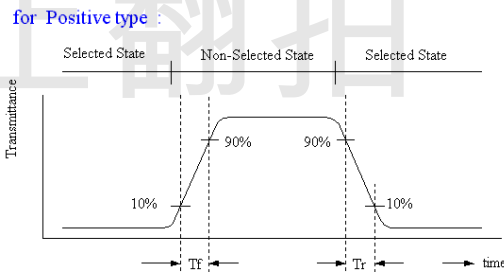
[Note 3] Definition of Viewing Angle :

0°
$\Theta 1-$ $\Theta 1+$
Viewing Direction

0°
$\Theta 2-$ $\Theta 2+$
Left   Right
Viewing Direction
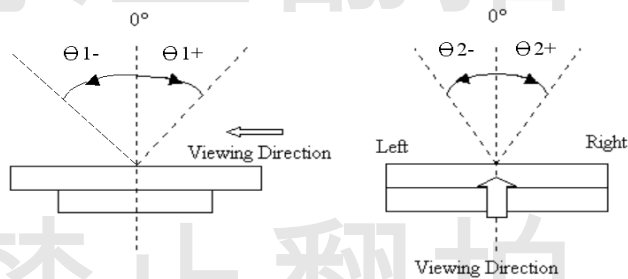
[Note 4] Definition of Contrast Ratio :

for Positive type

Transmittance

$\Theta 1=0$, $\Theta 2=0$ TH

Selected Segment
Non-Selected Segment

TL

Vop   Voltage

$$\text{Contrast Ratio} = \frac{TH}{TL}$$
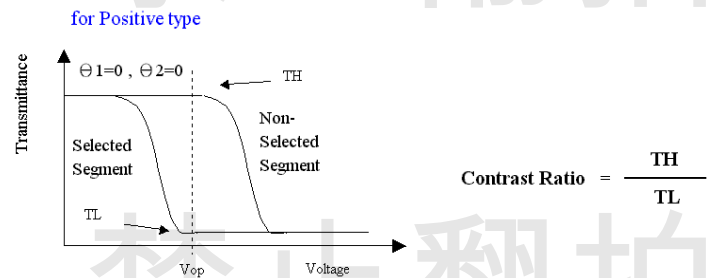
[Note 5] Definition of measurement of Color Chromaticity and Brightness

BM-7

500mm

LCD Module
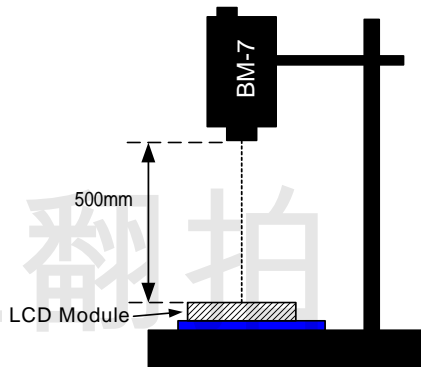
[Note 6] Definition of Brightness Uniformity

W / 4

H / 4

Active Area Height : H

① ② ③
④ ⑤ ⑥
⑦ ⑧ ⑨

Active Area Width : W
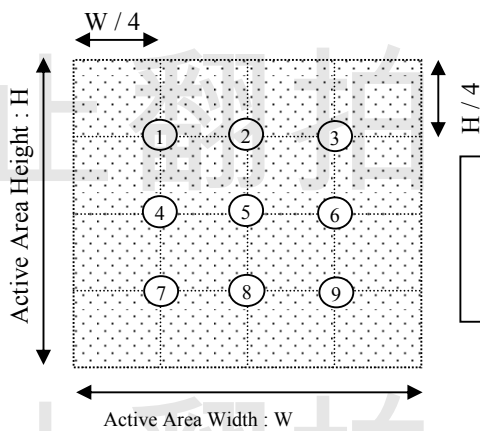
$$\text{Brightness Uniformity} = \frac{\text{Minimum Brightness of Point 1~9}}{\text{Maximum Brightness of Point 1~9}}$$

[Note 7] Definition of Measurement of Reflectance

BM-7

White Light Source
(Ring)

500mm

15 deg.

LCD Module
or referance
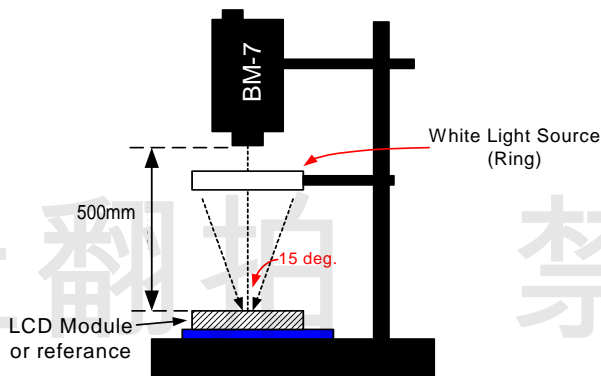
4. RELIABILITY :

Item No	Items	Condition	Note
1	High temperature operating	70 , 200 hours	1
2	Low temperature operating	-20 , 200 hours	1
3	High temperature storage	80 , 200 hours	1
4	Low temperature storage	-30 , 200 hours	1
5	High temperature & humidity storage	60 , 90%RH, 100 hours	2
6	Thermal Shock storage	-30 , 30min.<=> 80 , 30min. 10 Cycles	1
7	Vibration test	10 => 55 =>10 => 55 => 10 Hz , within 1 minute Amplitude : 1.5mm. 15 minutes for each Direction (X,Y,Z)	
8	Drop test	Packed, 100CM free fall, 6 sides, 1 corner, 3edges	
9	Life time	50,000 hours 25 , 60%RH , specification condition driving	

Note 1   The product move into the room temperature for at least 2 hours with no condensation.

Note 2   The product move into the room temperature for at least 24 hours with no condensation.

Note 3 : Please change the display picture (autorun) during operating mode. Avoid displaying static images to avoid image sticking , and the image sticking is accelerated by temperature.

  * One single product test for only one item.

  * Judgment after test : keep in room temperature for more than 2 hours.

    - Current consumption < 2 times of initial value

    - Contrast > 1/2 initial value

    - Function : work normally

5. PRODUCT HANDLING AND APPLICATION

PRECAUTION FOR HANDLING LCM.

The LCD module contains a C-MOS LSI. People who operate the LCM should wear ESD protection eguipement to prevent ESD hurt on products.

Do not input any signal before power is turned on.

Do not take LCM from its packaging bag until it is assembled.

Peel off the LCM protective film slowly since static electricity may be generated.

Pay attention to the humidity of the work shop, 50~60%RH is satisfactory.

Use a non-leak iron for soldering LCM.

Do not touch the display surface or connection terminals area with bare hands.Smudges on the display surface reduce the insulation between terminals.

Cautions for soldering to LCM:

Condition for soldering I/O terminals:

Temperature at iron tip :350　±15　.

Soldering time : 3~4sec./ terminals.

Type of solder : Eutectic solder(rosin flux filled).

PRECAUTION IN USE OF LCD

Do not contact or scratch the front surface and the contact pads of a LCD panel with hard materials such as metal or glass or with one's nail.

To clean the surface , wipe it gently with soft cloth dampened by alcohol.

Do not attempt to wiped off the contact pads.

Keep LCD panels away from direct sunlight , also avoid them in high-temperature & high humidity environment for a long period.

Do not drive LCD panels by DC voltage.

Do not expose LCD panels to organic solvent.

Liquid in LCD is hazardous substance. In case a contact with liquid crystal material is occured, be sure to immediately wash such material away by soap and water.

The polarizer is easily damaged and should be handle with special care. Don't press or rub it with hard objects.

PRECAUTION FOR STORING AND USE OF LCM.

To avoid degradation of the device , do not store the module under the conditions of direct sunlight , high temperature or high humidity . Keep the module in bags designed to prevent static electricity charging under low temperature / normal humidity conditions(avoid high temperature / high humidity and low temperature below 0　)

Never use the LCD , LCM under 45 Hz , the liquid crystal will decomposition and cause permently damage on display !!

USING ON MEDICAL CARE , SAFETY OR HAZARDOUS APPLICATION OR SYSTEM.

For the application in medical care, safety and hazardous prodcuts or systems, an authorization from URT is required. URT will not responsible for any damage or loss which caused by the products without any authorization given by URT.

This product is not allowed to be designed and used for military application and/or purpose.

The delivery of this product to the countries and/or regions where the embargoes are imposed by U.N. is prohibited.

The application and delivery of this product must comply with Startegic High-Tech Commodities (SHTC) export control and the sales to the embargoed and/or sanctioned countries or regions are strictly prohibited.

6. DATE CODE OF PRODUCTS

Date code will be shown on each product :

YY **MM** **DD** - **XXXX**

Year Month Day - Serial no.

Example: 141108 - 0003 ==> Year 2014, November,8th ,Serial no.0003

Note   The lot no. attached on the packing box will be used for tracking once the part is too small to print the date code.

7. LOT NO & PACKING

Instruction of lot number:

LOT NO. : 0 0 0 8 3 5 2 5 (EX)

Date   01—1 st
        02—2 nd
        |
        31—31 th

Week   1 ——— 7

Week of   1 ——— 5
Month

Month   01—January
         02—February
         |
         12—December

Year   00—2000
        01—2001

Lable of carton:

Carton Box

FRAGILE 落下嚴禁

CSNO
MADE IN TAIWAN

MODEL:XXXX—XXXXXX—XX
Q'TY: PCS
LOT   NO.
N.W.   KGS.
G.W.   KGS.
UNITED RADIANT TECHNOLOGY CORP.
光聯科技股份有限公司

UP
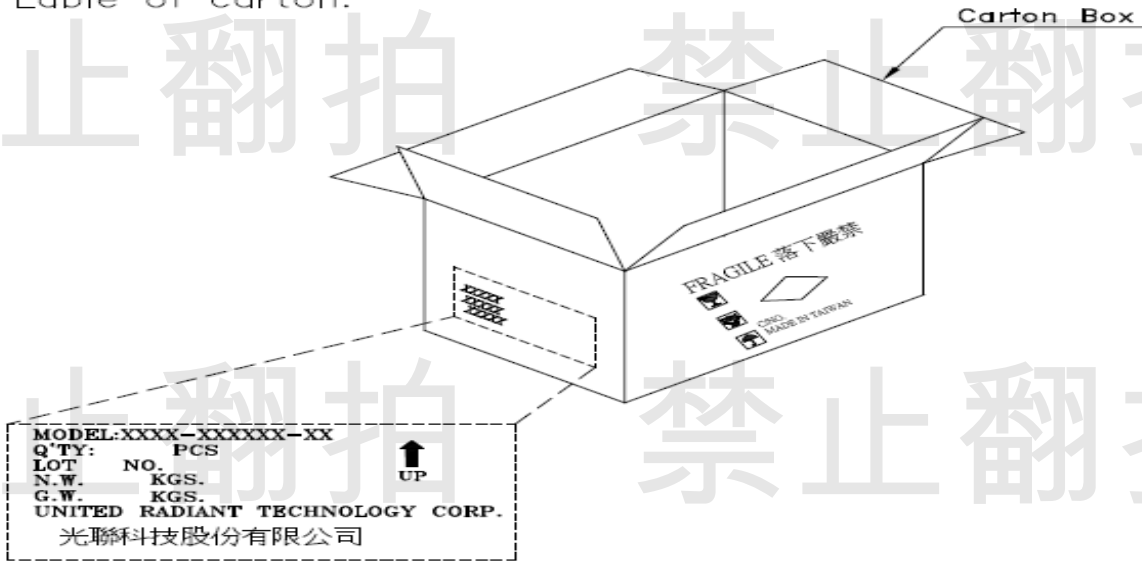
Packing tray must be stacked with alternated direction to each others.
To tacks packing trays in same direction will cause product damaged.

Not Allowed

OK

Not Allowed

OK
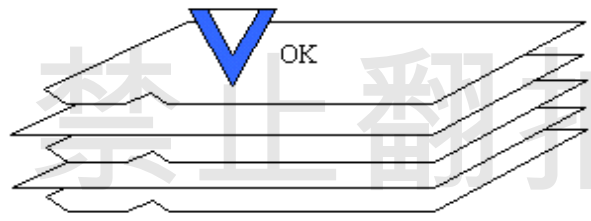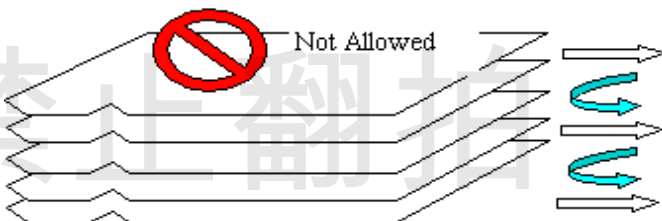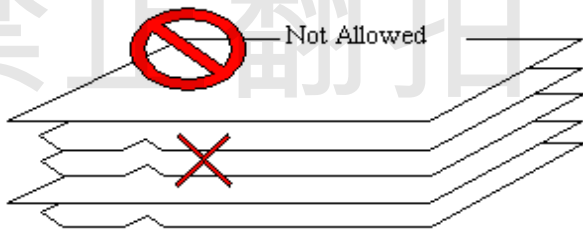
MODEL NO : UMSH-8065MD-11T

6   pcs / Tray
7+1   Tray / Box
4   Box / Carton
168   pcs / Carton

NOTE:
(1)Be warned ,the direction of
the tray has to turn it by 180 degree
before stack it up.Otherwise,
it will be packager's responsibility!!
(2)Safe Stack : 5 cartons only

TAPE

7+1 TRAY
(1 empty tray)

Corrugated board
protection

Model		No.
Q'ty		pcs
*		
Lot	No.	

FRAGILE 落下嚴禁
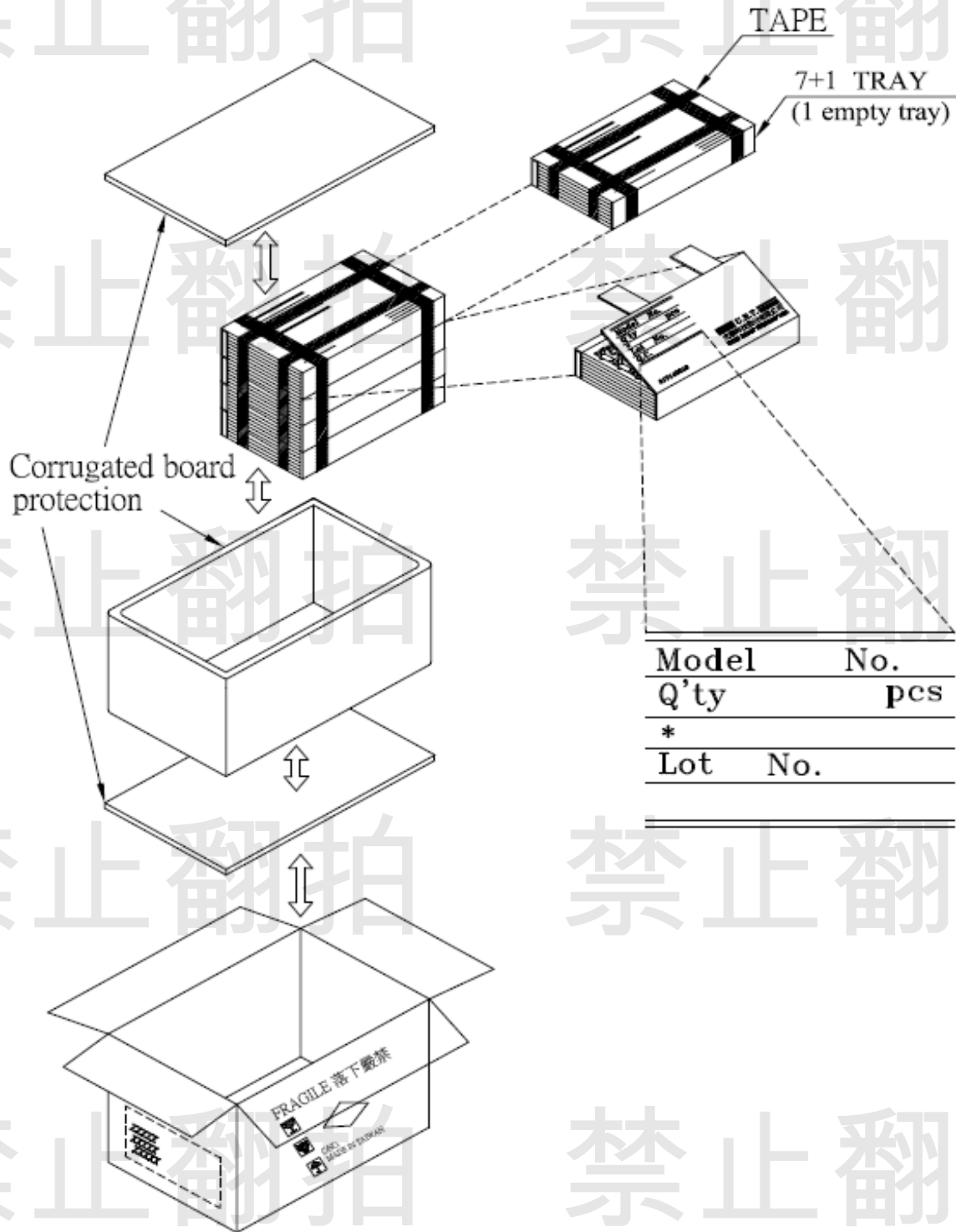
8. INSPECTION STANDARD

8.1. QUALITY :

THE QUALITY OF GOODS SUPPLIED TO PURCHASER SHALL COME UP TO THE FOLLOWING STANDARD.

8.1.1. THE METHOD OF PRESERVING GOODS

AFTER DELIVERY OF GOODS FROM U.R.T. TO PURCHASER. PURCHASER SHALL CONTROL THE LCM

AT -10   TO 40   ,AND IT MIGHT BE DESIRABLE TO KEEP AT THE NORMAL ROOM TEMPERATURE

AND HUMIDITY UNTIL INCOMING INSPECTION OR THROWING INTO PROCESS LINE.

8.1.2. INCOMING INSPECTION

(A) THE METHOD OF INSPECTION

IF PURCHASER MAKE AN INCOMING INSPECTION , A SAMPLING PLAN SHALL BE

APPLIED ON THE CONDITION THAT QUALITY OF ONE DELIVERY SHALL BE

REGARDED AS ONE LOT.

(B) THE STANDARD OF QUALITY

ISO-2859-1 (or MIL-STD-105E) , LEVEL   SINGLE PLAN.

CLASS	AQL(%)
CRITICAL	0.4 %
MAJOR	0.65 %
MINOR	1.5 %

EVERY ITEM SHALL BE INSPECTED ACCORDING TO THE CLASS.

(C) MEASURE

IF AS THE RESULT OF ABOVE RECEIVING INSPECTION , A LOT OUT IS DISCOVERED.

PURCHASER SHALL BE INFORM SELLER OF IT WITHIN SEVEN DAYS. BUT FIRST SHIPMENT

WITHIN FOURTEEN DAYS.

8.1.3. WARRANTY POLICY

U.R.T. WILL PROVIDE ONE-YEAR WARRANTY FOR THE PRODUCTS ONLY IF UNDER SPECIFICATION

OPERATING CONDITIONS. U.R.T. WILL REPLACE NEW PRODUCTS FOR THESE DEFECT PRODUCT

WHICH UNDER WARRANTY PERIOD AND BELONG TO THE RESPONSIBILITY OF U.R.T.

8.2. CHECKING CONDITION

8.2.1. VIEWING DISTANCE IS APPROXIMATELY 30 ± 5 CM.
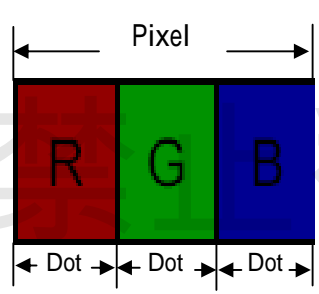
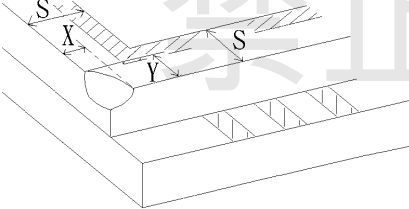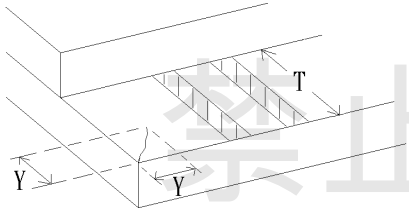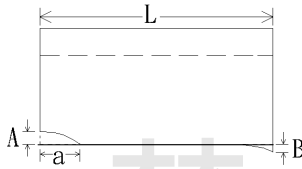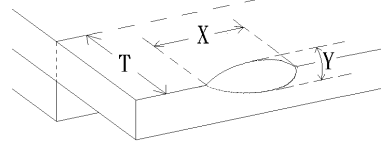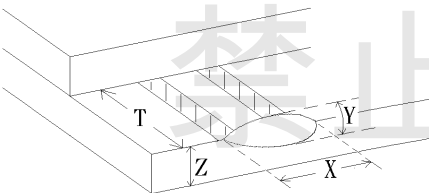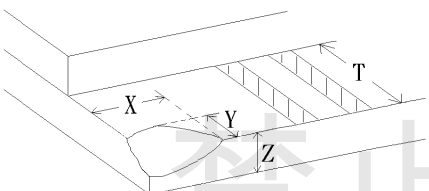**8.2.2.** VIEWING ANGLE IS NORMAL TO THE LCD PANEL WITH 45°.
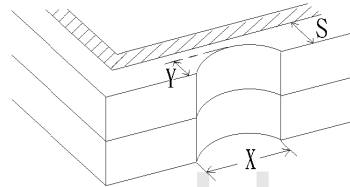
8.2.3. AMBIENT ILLUMINANCE   2 PCS OF 20W FLUORESCENT LAMPS(DISTANCE TO THE SAMPLE >100CM)

OR 1000 ± 200 LUX.

8.3. INSPECTION PLAN :

CLASS	ITEM	JUDGEMENT	CLASS
PACKING & INDICATE	1. OUTSIDE AND INSIDE PACKAGE	"MODEL NO." , "LOT NO." AND "QUANTITY" SHOULD INDICATE ON THE PACKAGE.	Minor
	2. MODEL MIXED AND QUANTITY	OTHER MODEL MIXED...............REJECTED QUANTITY SHORT OR OVER......REJECTED	Critical
	3. PRODUCT INDICATION	"MODEL NO." SHOULD INDICATE ON THE PRODUCT	Major
ASSEMBLY	4. DIMENSION, LCD GLASS SCRATCH AND SCRIBE DEFECT.	ACCORDING TO SPECIFICATION OR DRAWING.	Major
APPEARANCE	5. VIEWING AREA	POLARIZER EDGE OR LCD'S SEALING LINE IS VISABLE IN THE VIEWING AREA ....REJECTED	Minor
	6. BLEMISH BLACK SPOT WHITE SPOT IN THE LCD AND LCD GLASS CRACKS	ACCORDING TO STANDARD OF VISUAL INSPECTION (INSIDE VIEWING AREA)	Minor
	7. BLEMISH BLACK SPOT WHITE SPOT AND SCRATCH ON THE POLARIZER	ACCORDING TO STANDARD OF VISUAL INSPECTION (INSIDE VIEWING AREA)	Minor
	8. BUBBLE IN POLARIZER	ACCORDING TO STANDARD OF VISUAL INSPECTION (INSIDE VIEWING AREA)	Minor
	9. LCD'S RAINBOW COLOR	STRONG DEVIATION COLOR (OR NEWTON RING) OF LCD......REJECTED. OR ACCORDING TO LIMITED SAMPLE (IF NEEDED, AND INSIDE VIEWING AREA)	Minor
ELECTRICAL	10. ELECTRICAL AND OPTICAL CHARACTERISTICS (CONTRAST VOP CHROMATICITY … ETC)	ACCORDING TO SPECIFICATION OR DRAWING . (INSIDE VIEWING AREA)	Critical
	11.MISSING LINE	MISSING DOT LINE CHARACTER ....REJECTED	Critical
	12.SHORT CIRCUIT WRONG PATTERN DISPLAY	NO DISPLAY WRONG PATTERN DISPLAY CURRENT CONSUMPTION OUT OF SPECIFICATION...... REJECTED	Critical
	13. DOT DEFECT (FOR COLOR AND TFT)	ACCORDING TO STANDARD OF VISUAL INSPECTION	Minor

8.4. STANDARD OF VISUAL INSPECTION

NO.	CLASS	ITEM	JUDGEMENT
8.4.1	MINOR	BLACK AND WHITE SPOT FOREIGN MATERIEL DUST IN THE CELL BLEMISH SCRATCH	(A) ROUND TYPE: unit : mm. (B) LINEAR TYPE: unit : mm.
8.4.2	MINOR	BUBBLE IN POLARIZER DENT ON POLARIZER	unit : mm.
8.4.3	MINOR	Dot Defect	

8.4.1 (A) ROUND TYPE: unit : mm.

DIAMETER (mm.)		ACCEPTABLE Q'TY
	0.1	DISREGARD
0.1 <	0.25	3 (D>5mm)
0.25 <		0

NOTE: =(LENGTH+WIDTH)/2

(B) LINEAR TYPE: unit : mm.

LENGTH	WIDTH		ACCEPTABLE Q'TY
------	W	0.03	DISREGARD
L 5.0	0.03 < W	0.07	3 (D>5mm)
------	0.07 < W		FOLLOW ROUND TYPE

8.4.2 unit : mm.

DIAMETER		ACCEPTABLE Q'TY
	0.2	DISREGARD
0.2 <	0.5	2 (D>5mm)
0.5 <		0

8.4.3 Dot Defect

Items	ACC. Q'TY
Bright dot	N 4 (D>5mm)
Dark dot	N 4 (D>5mm)

Pixel Define

Not 1: The definition of dot: The size of a defective dot over

1/2 of whole dot is regarded as one defective dot.

Not 2: Bright dot: Dots appear bright and unchanged in size

in which LCD panel is displaying under black pattern.

Not 3: Dark dot: Dots appear dark and unchanged in size in

which LCD panel is displaying under pure red, green

,blue pattern.

NO.	CLASS	ITEM	JUDGEMENT	
8.4.4	MINOR	LCD GLASS CHIPPING	$Y > S$	Reject
8.4.5	MINOR	LCD GLASS CHIPPING	X or $Y > S$	Reject
8.4.6	MAJOR	LCD GLASS GLASS CRACK	$Y > (1/2) T$	Reject
8.4.7	MAJOR	LCD GLASS SCRIBE DEFECT	1. $a > L/3$, $A > 1.5$mm. Reject 2. B : ACCORDING TO DIMENSION	
8.4.8	MINOR	LCD GLASS CHIPPING (ON THE TERMINAL AREA)	$= (x+y)/2 > 2.5$ mm	Reject
8.4.9	MINOR	LCD GLASS CHIPPING (ON THE TERMINAL SURFACE)	$Y > (1/3) T$	Reject
8.4.10	MINOR	LCD GLASS CHIPPING	$Y > T$	Reject